

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HUAXIANG YIN	09/18/2014
XIAOLONG MA	09/18/2014
WEIJIA XU	09/18/2014
QIUXIA XU	09/18/2014
HUILONG ZHU	09/18/2014
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<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	100029
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	14387830
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<b>ATTORNEY DOCKET NUMBER:</b>	5006.0008WU1
<b>NAME OF SUBMITTER:</b>	JULIE A. ERICKSON
<b>SIGNATURE:</b>	/Julie A. Erickson/
<b>DATE SIGNED:</b>	11/03/2014
<b>Total Attachments: 2</b>	

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ASSIGNMENT

WHEREAS, we, Huaxiang YIN, Xiaolong MA, Weijia XU, Qiuxia XU, and Huilong ZHU ("Assignors"), have invented certain new and useful improvements in **METHOD OF MANUFACTURING MOS TRANSISTOR WITH STACK OF CASCADED NANOWIRES**, for which an application for Letters Patent of the U. S. has been made, and which may be identified in the U. S. Patent Office by Application No. 14/387,830, filed September 24, 2014.

WHEREAS, INSTITUTE OF MICROELECTRONICS, CHINESE ACADEMY OF SCIENCES, a business entity organized and existing under the laws of the Country of China, and having its principal offices at No.3 Beitucheng West Road, Chaoyang District, Beijing 100029 China, ("Assignee"), is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor,

NOW, THEREFORE, for and in consideration of good and valuable consideration paid by Assignee to Assignors, the receipt and sufficiency of which is hereby acknowledged by us, we have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto said Assignee, its successors and assigns, our entire right, title and interest in and to said invention, said application, all applications claiming priority to said application including all divisions, continuations or renewals thereof, and the Letters Patent, both foreign and domestic, that may or shall issue, therefrom including all reissues or extensions of such patents including all of our rights under the International Convention and further including the right to sue, counterclaim and recover for past, present and future infringement of the rights assigned or to be assigned, as fully and entirely as the same would have been held by the Assignors if this assignment had not been made, and we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned Assignee in accordance herewith.

We hereby authorize the above mentioned Assignee, its successors and assigns, or anyone they may properly designate, to insert in this instrument the date of execution and/or filing date and application number of said application when ascertained.

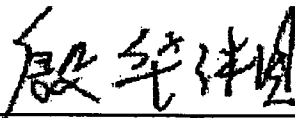
We further authorize said Assignee, its successors and assigns, or anyone they may properly designate, to apply for Letters Patent, in their own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of the International Convention.

Upon said consideration we do hereby covenant and agree with said Assignee, its successors and assigns, that we will not execute in writing or do any act whatsoever conflicting with these presents, and that we or our executors or administrators will at any time upon request, without further or additional consideration, but at the expense of said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or of any and all foreign

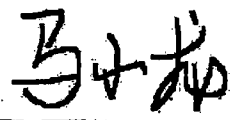
Attorney Docket No.:

countries on said invention, and in enforcing any rights occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

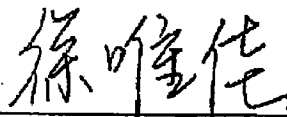
Date: 18/9/2014  
Day/Month/Year

  
Huaxiang YIN

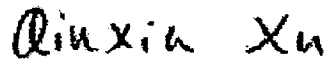
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Xiaolong MA

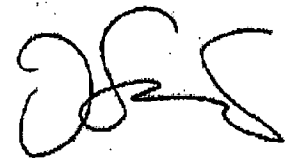
Date: 18/9/2014  
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Weijia XU

Date: 18/9/2014  
Day/Month/Year

  
Qiuxia XU

Date: 18/9/2014  
Day/Month/Year

  
Huilong ZHU